

CURRENT 20 Ampere  
VOLTAGE RANG 200 Volts

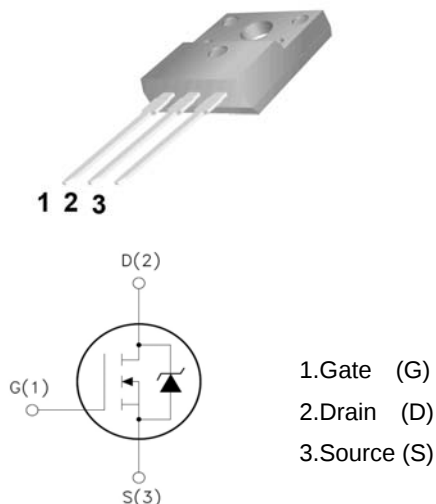
**ASE20N20F**

## ASE20N20F

### Features:

- ☐ Low Intrinsic Capacitances
- ☐ Excellent Switching Characteristics
- ☐ Extended Safe Operating Area
- ☐ Unrivalled Gate Charge :Qg= 45nC (Typ.)
- ☐ BVDSS=200V, ID=20A
- ☐  $R_{DS(on)}$  :0.18  $\Omega$  (Max) @VG=10V
- ☐ 100% Avalanche

### TO-220F



### Absolute Maximum Ratings (Ta=25°C unless otherwise noted)

| Symbol       | Parameter                                                                    | Value                   | Unit             |
|--------------|------------------------------------------------------------------------------|-------------------------|------------------|
| $V_{DSS}$    | Drain-Source Voltage                                                         | 200                     | V                |
| $I_D$        | Drain Current                                                                | $T_j=25^\circ\text{C}$  | A                |
|              |                                                                              | $T_j=100^\circ\text{C}$ |                  |
| $V_{GS(TH)}$ | Gate Threshold Voltage                                                       | $\pm 30$                | V                |
| $E_{AS}$     | Single Pulse Avalanche Energy (note1)                                        | 250                     | mJ               |
| $I_{AR}$     | Avalanche Current (note2)                                                    | 18                      | A                |
| $P_D$        | Power Dissipation ( $T_j=25^\circ\text{C}$ )                                 | 46                      | W                |
| $T_j$        | Junction Temperature(Max)                                                    | 150                     | $^\circ\text{C}$ |
| $T_{stg}$    | Storage Temperature                                                          | -55~+150                | $^\circ\text{C}$ |
| TL           | Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds | 300                     | $^\circ\text{C}$ |

### Thermal Characteristics

| Symbol          | Parameter                               | Typ. | Max. | Unit               |
|-----------------|-----------------------------------------|------|------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case    | -    | 3.1  | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | -    | 62.5 | $^\circ\text{C/W}$ |

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### Electrical Characteristics (Ta=25°C unless otherwise noted)

| Symbol                                                 | Parameter                                 | Test Condition                                                               | Min. | Typ. | Max. | Unit |
|--------------------------------------------------------|-------------------------------------------|------------------------------------------------------------------------------|------|------|------|------|
| Off Characteristics                                    |                                           |                                                                              |      |      |      |      |
| BV <sub>DSS</sub>                                      | Drain-Source Breakdown Voltage            | I <sub>D</sub> =250μA, V <sub>GS</sub> =0                                    | 200  | -    | -    | V    |
| ΔBVDSS/ΔT <sub>J</sub>                                 | Breakdown Voltage Temperature Coefficient | I <sub>D</sub> =250μA ,Reference to 25℃                                      | -    | 0.25 | -    | V/℃  |
| I <sub>DSS</sub>                                       | Zero Gate Voltage Drain Current           | V <sub>DS</sub> =200V, V <sub>GS</sub> =0V                                   | -    | -    | 1    | μA   |
|                                                        |                                           | V <sub>DS</sub> =160V, T <sub>j</sub> =125℃                                  |      |      | 10   |      |
| I <sub>GSSF</sub>                                      | Gate-body leakage Current, Forward        | V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V                                   | -    | -    | 100  | nA   |
| I <sub>GSSR</sub>                                      | Gate-body leakage Current, Reverse        | V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V                                   | -    | -    | -100 |      |
| On Characteristics                                     |                                           |                                                                              |      |      |      |      |
| V <sub>GS(TH)</sub>                                    | Date Threshold Voltage                    | I <sub>D</sub> =250μA,V <sub>DS</sub> =V <sub>GS</sub>                       | 2    | -    | 4    | V    |
| R <sub>DS(ON)</sub>                                    | Static Drain-Source On-Resistance         | I <sub>D</sub> =20A,V <sub>GS</sub> =10V                                     | -    | -    | 0.18 | Ω    |
| Dynamic Characteristics                                |                                           |                                                                              |      |      |      |      |
| C <sub>iss</sub>                                       | Input Capacitance                         | V <sub>DS</sub> =25V, V <sub>GS</sub> =0, f=1.0MHz                           | -    | 1250 | 1380 | pF   |
| C <sub>oss</sub>                                       | Output Capacitance                        |                                                                              | -    | 200  | 260  |      |
| C <sub>rss</sub>                                       | Reverse Transfer Capacitance              |                                                                              | -    | 25   | 33   |      |
| Switching Characteristics                              |                                           |                                                                              |      |      |      |      |
| T <sub>d(on)</sub>                                     | Turn-On Delay Time                        | V <sub>DD</sub> =100V, I <sub>D</sub> =20A<br>R <sub>G</sub> =25Ω (Note 3,4) | -    | 16   | 40   | ns   |
| T <sub>r</sub>                                         | Turn-On Rise Time                         |                                                                              | -    | 133  | 275  |      |
| T <sub>d(off)</sub>                                    | Turn-Off Delay Time                       |                                                                              | -    | 38   | 85   |      |
| T <sub>f</sub>                                         | Turn-Off Rise Time                        |                                                                              | -    | 62   | 135  |      |
| Q <sub>g</sub>                                         | Total Gate Charge                         | V <sub>DS</sub> =160V,V <sub>GS</sub> =10V, I <sub>D</sub> =20A (Note 3,4)   | -    | 20   | 26   | nC   |
| Q <sub>gs</sub>                                        | Gate-Source Charge                        |                                                                              | -    | 5.6  | -    |      |
| Q <sub>gd</sub>                                        | Gate-Drain Charge                         |                                                                              | -    | 10   | -    |      |
| Drain-Source Diode Characteristics and Maximum Ratings |                                           |                                                                              |      |      |      |      |
| I <sub>S</sub>                                         | Max. Diode Forward Current                | -                                                                            | -    | -    | 20   | A    |
| I <sub>SM</sub>                                        | Max. Pulsed Forward Current               | -                                                                            | -    | -    | 72   |      |
| V <sub>SD</sub>                                        | Diode Forward Voltage                     | I <sub>D</sub> =20A                                                          | -    | -    | 1.5  | V    |
| T <sub>rr</sub>                                        | Reverse Recovery Time                     | I <sub>S</sub> =20A,V <sub>GS</sub> =0V<br>diF/dt=100A/μs                    | -    | 158  | -    | nS   |
| Q <sub>rr</sub>                                        | Reverse Recovery Charge                   | (Note3)                                                                      | -    | 1.0  | -    | μC   |

Notes : 1, L=3.0mH, I<sub>AS</sub>=18A, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω, Starting T<sub>J</sub>=25°C  
2, Repetitive Rating : Pulse width limited by maximum junction temperature  
3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%  
4, Essentially Independent of Operating Temperature

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## Typical Characteristics

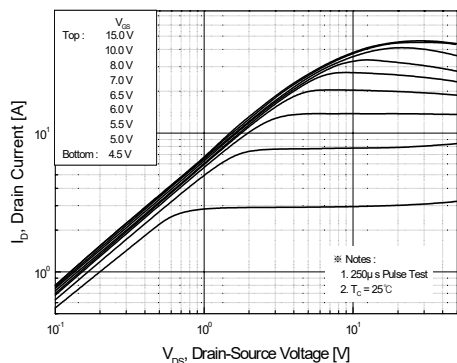


Figure 1. On-Region Characteristics

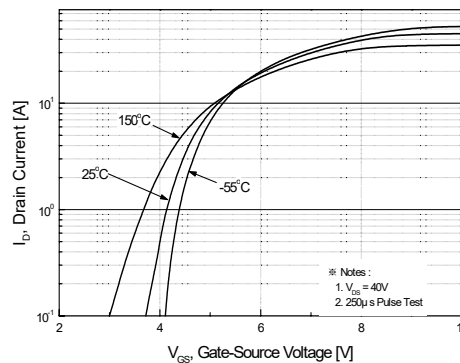


Figure 2. Transfer Characteristics

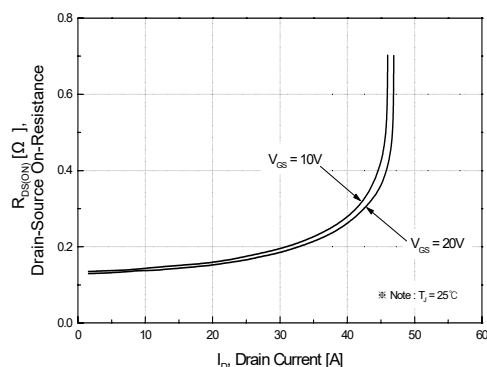


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

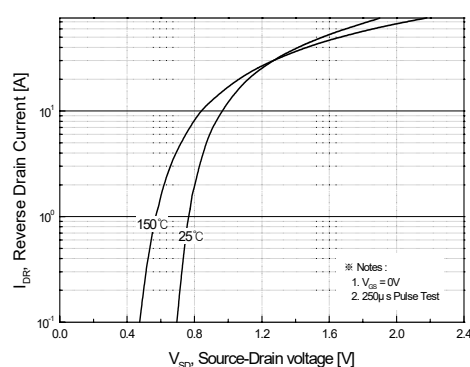


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

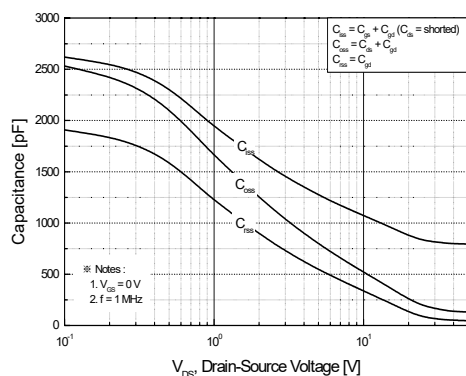


Figure 5. Capacitance Characteristics

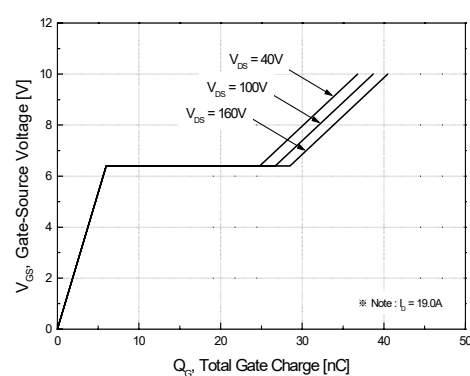
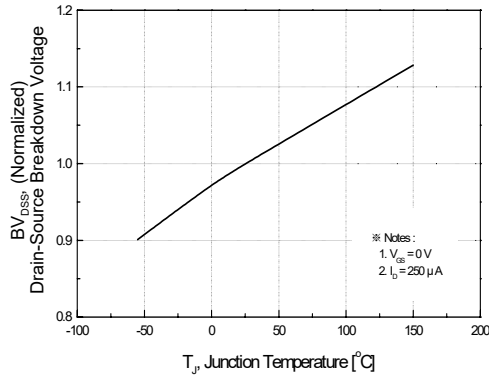


Figure 6. Gate Charge Characteristics

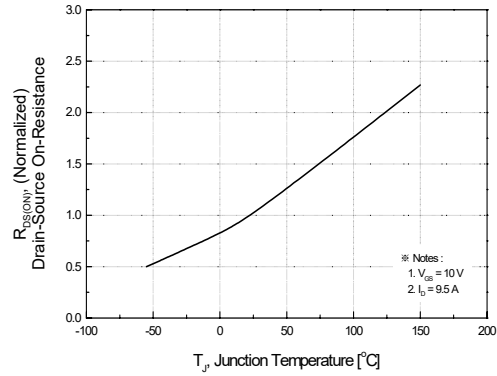
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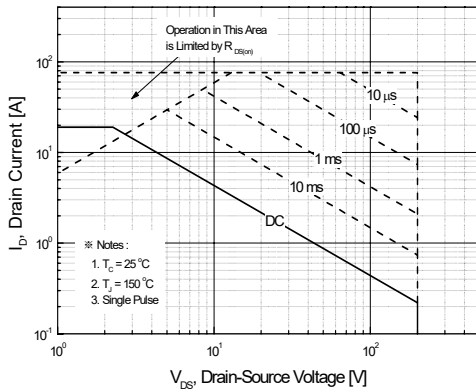
**Typical Characteristics (Continued)**



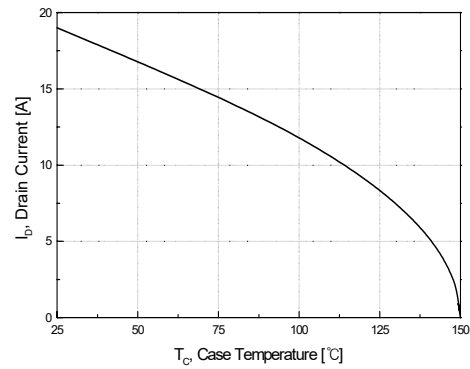
**Figure 7. Breakdown Voltage Variation vs Temperature**



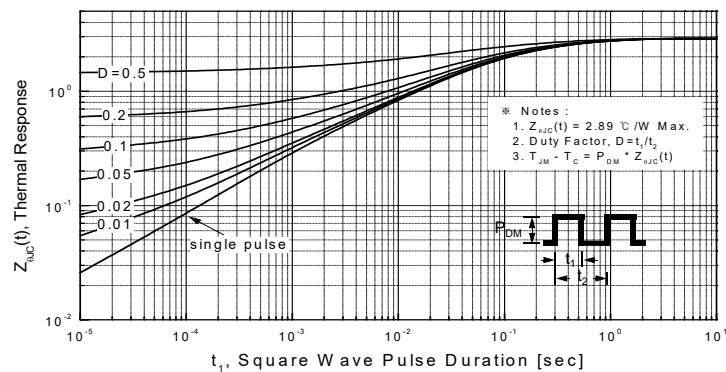
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9-2. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs Case Temperature**

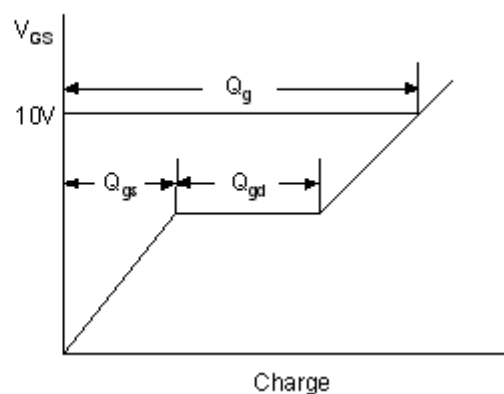
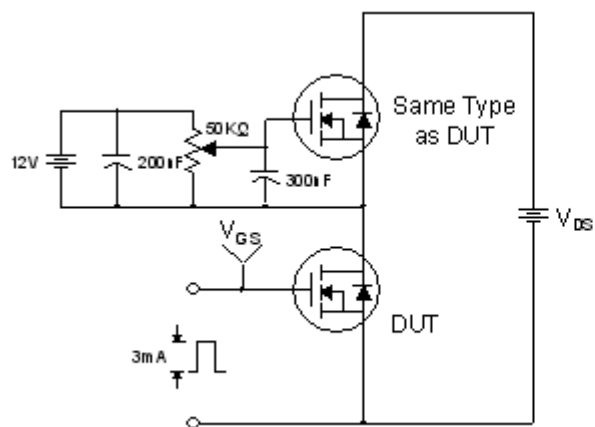


**Figure 11-2. Transient Thermal Response Curve**

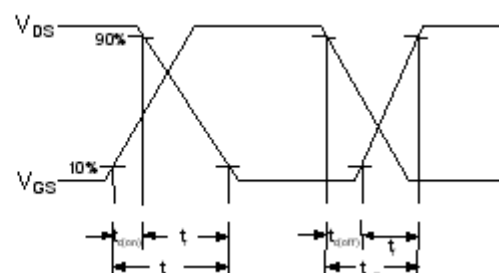
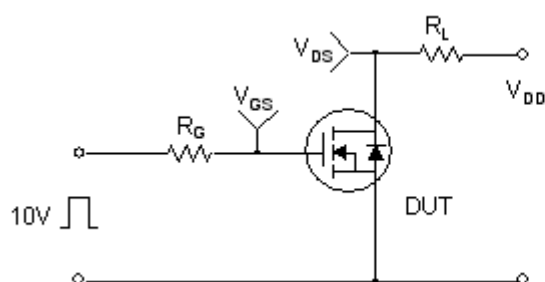
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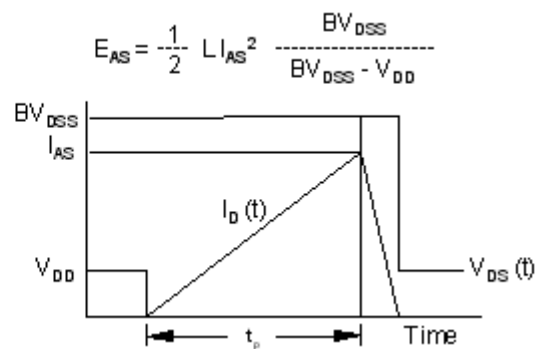
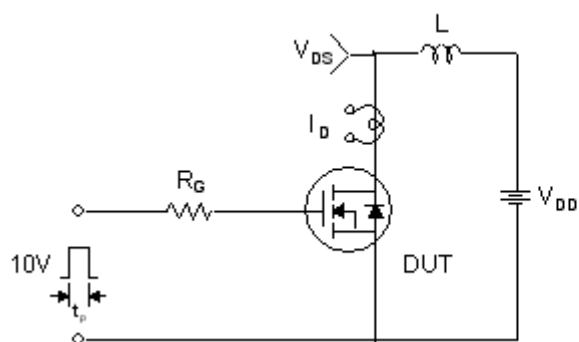
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



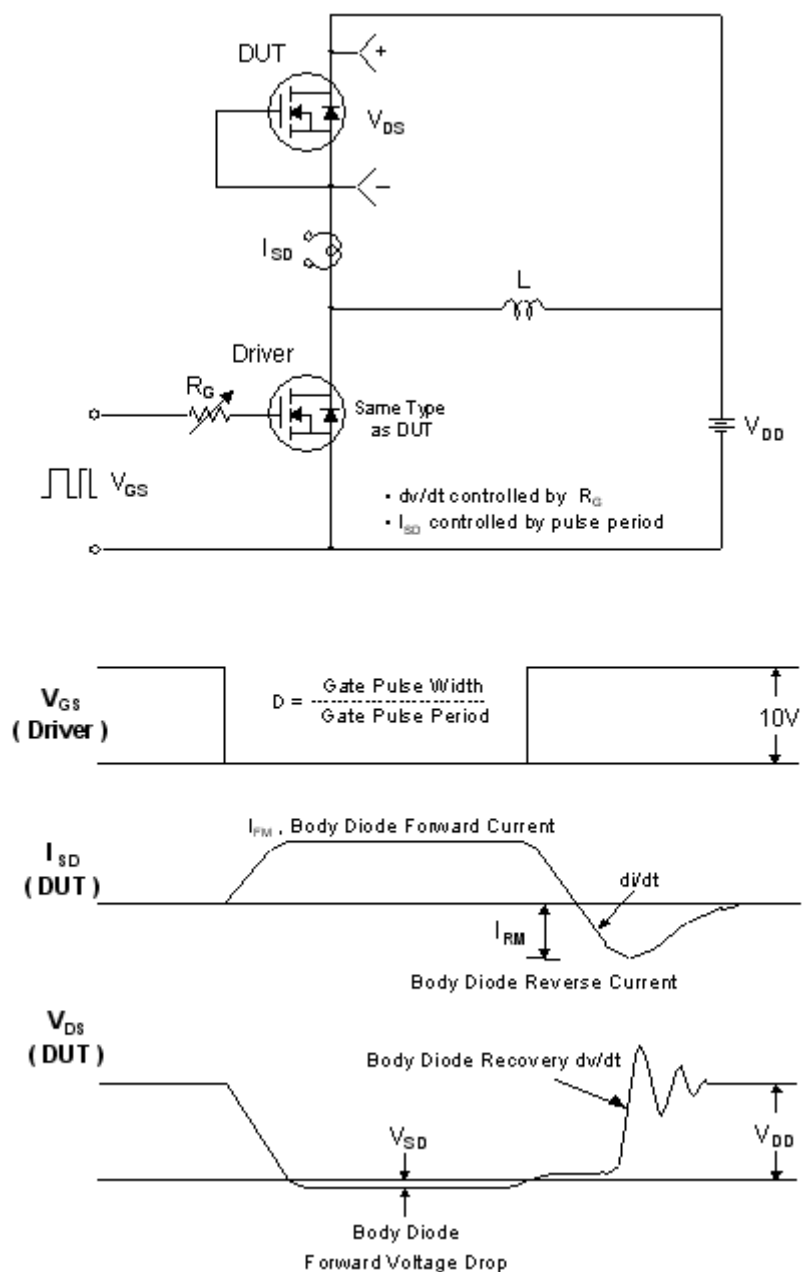
Unclamped Inductive Switching Test Circuit & Waveforms



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Peak Diode Recovery dv/dt Test Circuit & Waveforms



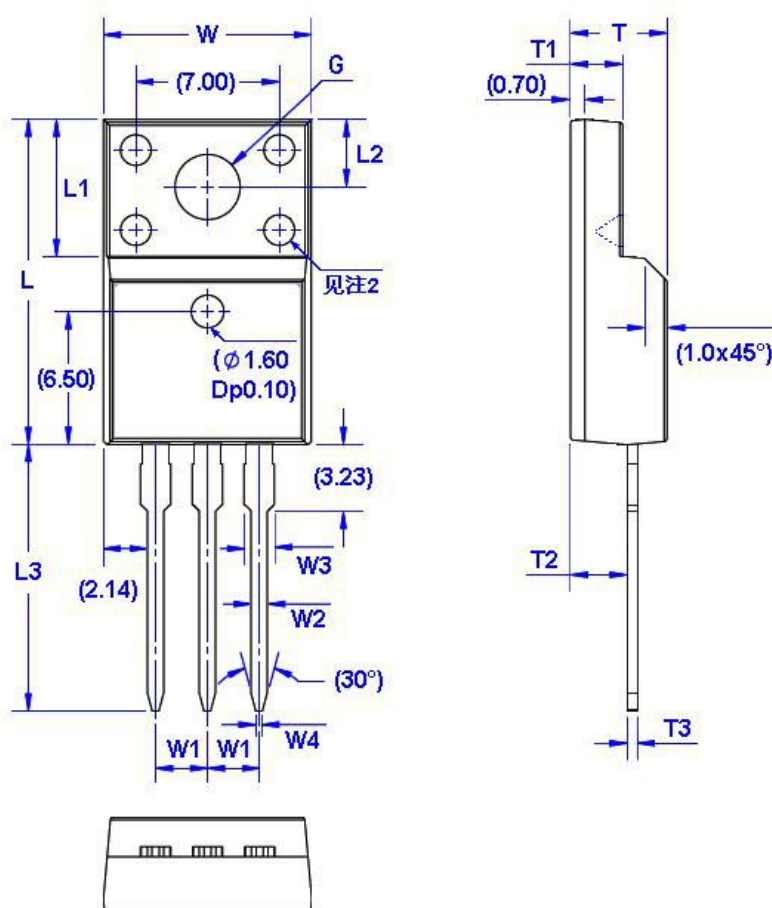
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**Package Dimension**

TO-220F

Unit: mm



| 符号 | 尺寸         |       | 符号 | 尺寸    |       | 符号 | 尺寸    |       | 符号   | 尺寸   |      |
|----|------------|-------|----|-------|-------|----|-------|-------|------|------|------|
|    | Min        | Max   |    | Min   | Max   |    | Min   | Max   |      | Min  | Max  |
| W  | 9.96       | 10.36 | W4 | 0.25  | 0.45  | L3 | 12.78 | 13.18 | T3   | 0.45 | 0.60 |
| W1 | 2.54 (TYP) |       | L  | 15.67 | 16.07 | T  | 4.50  | 4.90  | G(Φ) | 3.08 | 3.28 |
| W2 | 0.70       | 0.90  | L1 | 6.48  | 6.88  | T1 | 2.34  | 2.74  |      |      |      |
| W3 | 1.24       | 1.47  | L2 | 3.20  | 3.40  | T2 | 2.56  | 2.96  |      |      |      |